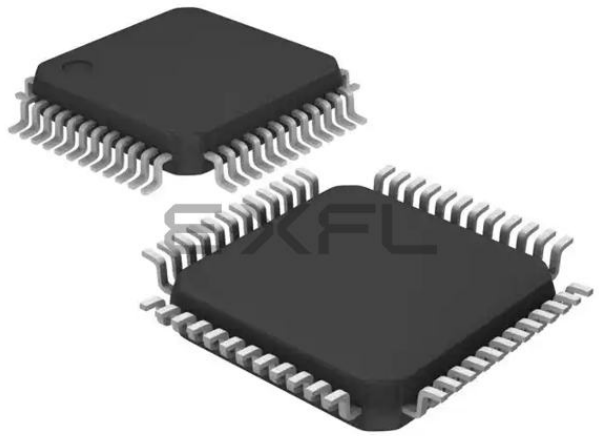

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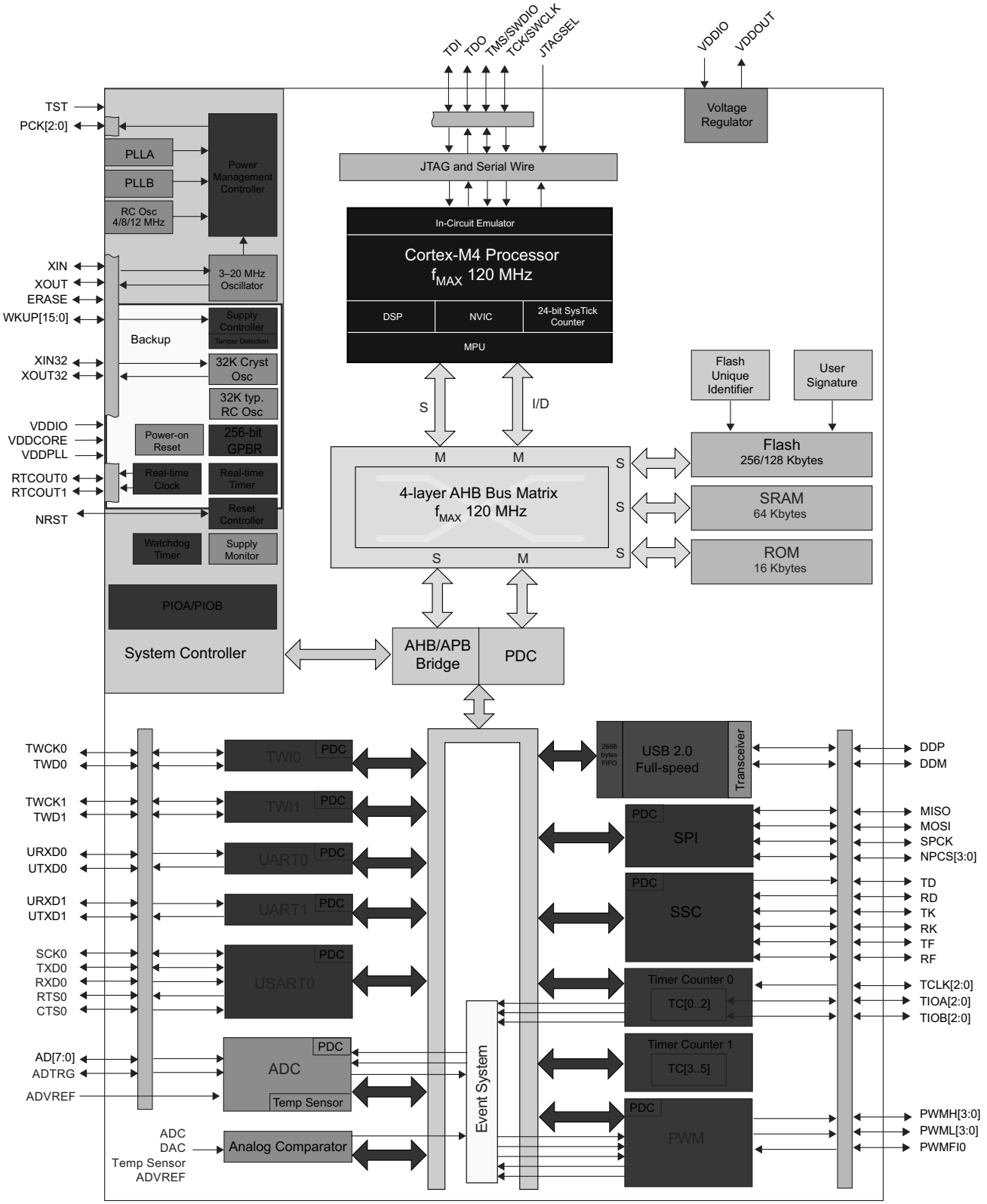
"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	ARM® Cortex®-M4
Core Size	32-Bit Single-Core
Speed	120MHz
Connectivity	I²C, IrDA, Memory Card, SPI, SSC, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	34
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	1.62V ~ 3.6V
Data Converters	A/D 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atsam4s4aa-au

Figure 2-7. SAM4S4/S2 48-pin Version Block Diagram



12.4.1.15 Base Priority Mask Register

Name: BASEPRI

Access: Read/Write

Reset: 0x000000000

31	30	29	28	27	26	25	24
–							

23	22	21	20	19	18	17	16
–							

15	14	13	12	11	10	9	8
–							

7	6	5	4	3	2	1	0
BASEPRI							

The BASEPRI register defines the minimum priority for exception processing. When BASEPRI is set to a nonzero value, it prevents the activation of all exceptions with same or lower priority level as the BASEPRI value.

- **BASEPRI**

Priority mask bits:

0x0000: No effect

Nonzero: Defines the base priority for exception processing

The processor does not process any exception with a priority value greater than or equal to BASEPRI.

This field is similar to the priority fields in the interrupt priority registers. The processor implements only bits[7:] of this field, bits[:0] read as zero and ignore writes. See “Interrupt Priority Registers” for more information. Remember that higher priority field values correspond to lower exception priorities.

- Do not use SP and do not use PC.
- *RdHi* and *RdLo* must be different registers.

Condition Flags

These instructions do not affect the condition code flags.

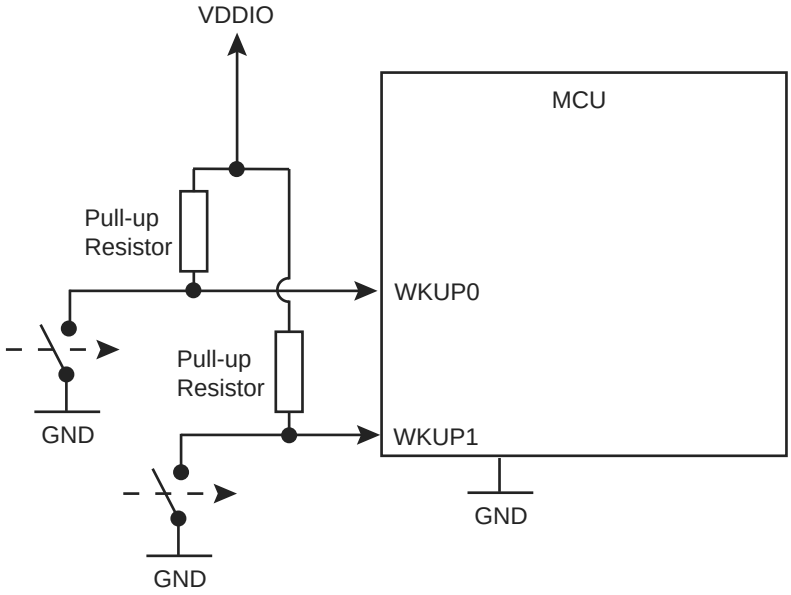
Examples

```
SMLAL    R4, R5, R3, R8  ; Multiplies R3 and R8, adds R5:R4 and writes to
                         ; R5:R4
SMLALBT  R2, R1, R6, R7  ; Multiplies bottom halfword of R6 with top
                         ; halfword of R7, sign extends to 32-bit, adds
                         ; R1:R2 and writes to R1:R2
SMLALTB  R2, R1, R6, R7  ; Multiplies top halfword of R6 with bottom
                         ; halfword of R7,sign extends to 32-bit, adds R1:R2
                         ; and writes to R1:R2
SMLALD   R6, R8, R5, R1  ; Multiplies top halfwords in R5 and R1 and bottom
                         ; halfwords of R5 and R1, adds R8:R6 and writes to
                         ; R8:R6
SMLALDX  R6, R8, R5, R1  ; Multiplies top halfword in R5 with bottom
                         ; halfword of R1, and bottom halfword of R5 with
                         ; top halfword of R1, adds R8:R6 and writes to
                         ; R8:R6.
```

tamper detection circuitry. If RTCOUTx is not used, the RTC must be configured to create an internal sampling point for the debouncer logic. The period of time between two samples can be configured by programming the TPERIOD field in RTC_MR.

Figure 18-8 illustrates the use of WKUPx without the RTCOUTx pin.

Figure 18-8. Using WKUP Pins Without RTCOUTx Pins



18.4.7.3 Clock Alarms

The RTC and the RTT alarms can generate a wake-up of the core power supply. This can be enabled by setting, respectively, the bits RTCEN and RTTEN in SUPC_WUMR.

The Supply Controller does not provide any status as the information is available in the user interface of either the Real-Time Timer or the Real-Time Clock.

18.4.7.4 Supply Monitor Detection

The supply monitor can generate a wake-up of the core power supply. See Section 18.4.4 ”Supply Monitor”.

For more details about VID/PID for End Product/Systems, please refer to the Vendor ID form available from the USB Implementers Forum on www.usb.org.

Atmel provides an INF example to see the device as a new serial port and also provides another custom driver used by the SAM-BA application: atm6124.sys. Refer to the application note “USB Basic Application”, Atmel literature number 6123, for more details.

24.5.3.1 Enumeration Process

The USB protocol is a master/slave protocol. This is the host that starts the enumeration sending requests to the device through the control endpoint. The device handles standard requests as defined in the USB Specification.

Table 24-3. Handled Standard Requests

Request	Definition
GET_DESCRIPTOR	Returns the current device configuration value.
SET_ADDRESS	Sets the device address for all future device access.
SET_CONFIGURATION	Sets the device configuration.
GET_CONFIGURATION	Returns the current device configuration value.
GET_STATUS	Returns status for the specified recipient.
SET_FEATURE	Set or Enable a specific feature.
CLEAR_FEATURE	Clear or Disable a specific feature.

The device also handles some class requests defined in the CDC class.

Table 24-4. Handled Class Requests

Request	Definition
SET_LINE_CODING	Configures DTE rate, stop bits, parity and number of character bits.
GET_LINE_CODING	Requests current DTE rate, stop bits, parity and number of character bits.
SET_CONTROL_LINE_STATE	RS-232 signal used to tell the DCE device the DTE device is now present.

Unhandled requests are STALLed.

24.5.3.2 Communication Endpoints

There are two communication endpoints and endpoint 0 is used for the enumeration process. Endpoint 1 is a 64-byte Bulk OUT endpoint and endpoint 2 is a 64-byte Bulk IN endpoint. SAM-BA Boot commands are sent by the host through endpoint 1. If required, the message is split by the host into several data payloads by the host driver.

If the command requires a response, the host can send IN transactions to pick up the response.

26.14.2 Switching from (to) Slow Clock Mode to (from) Normal Mode

When switching from Slow clock mode to Normal mode, the current Slow clock mode transfer is completed at high clock rate, with the set of Slow clock mode parameters.See Figure 26-29. The external device may not be fast enough to support such timings.

Figure 26-30 illustrates the recommended procedure to properly switch from one mode to the other.

Figure 26-29. Clock Rate Transition Occurs while the SMC is Performing a Write Operation

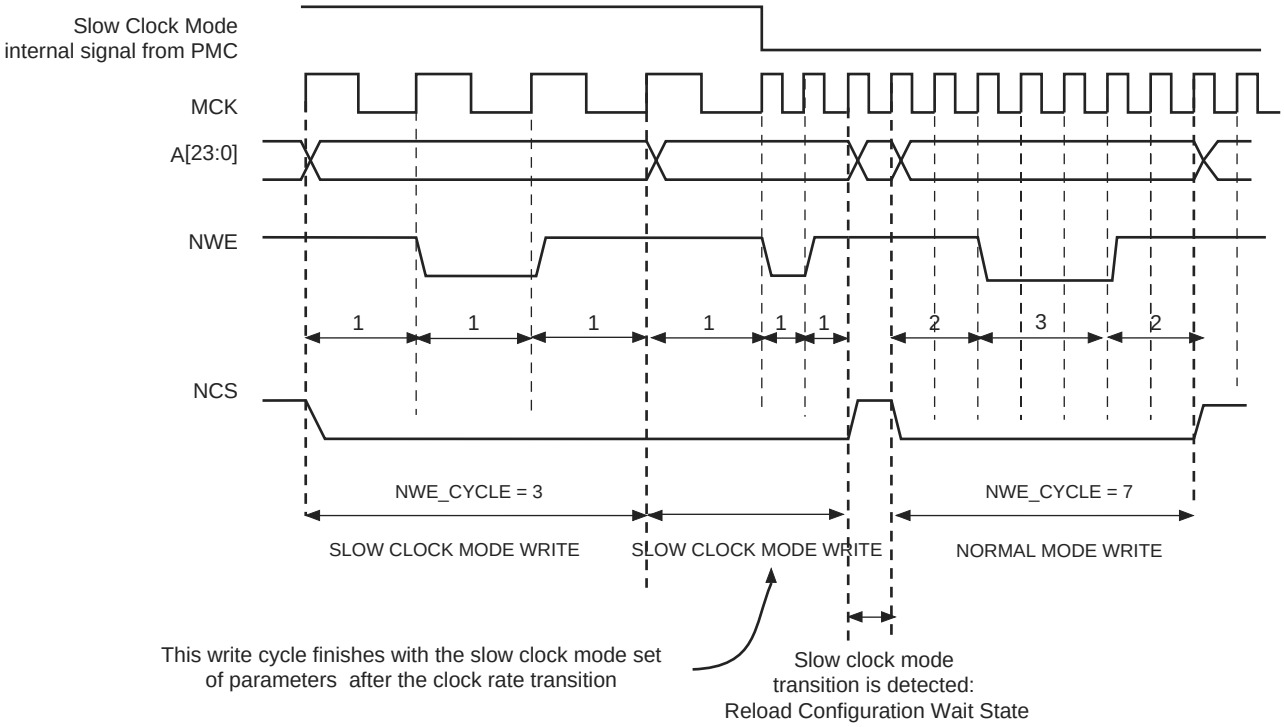
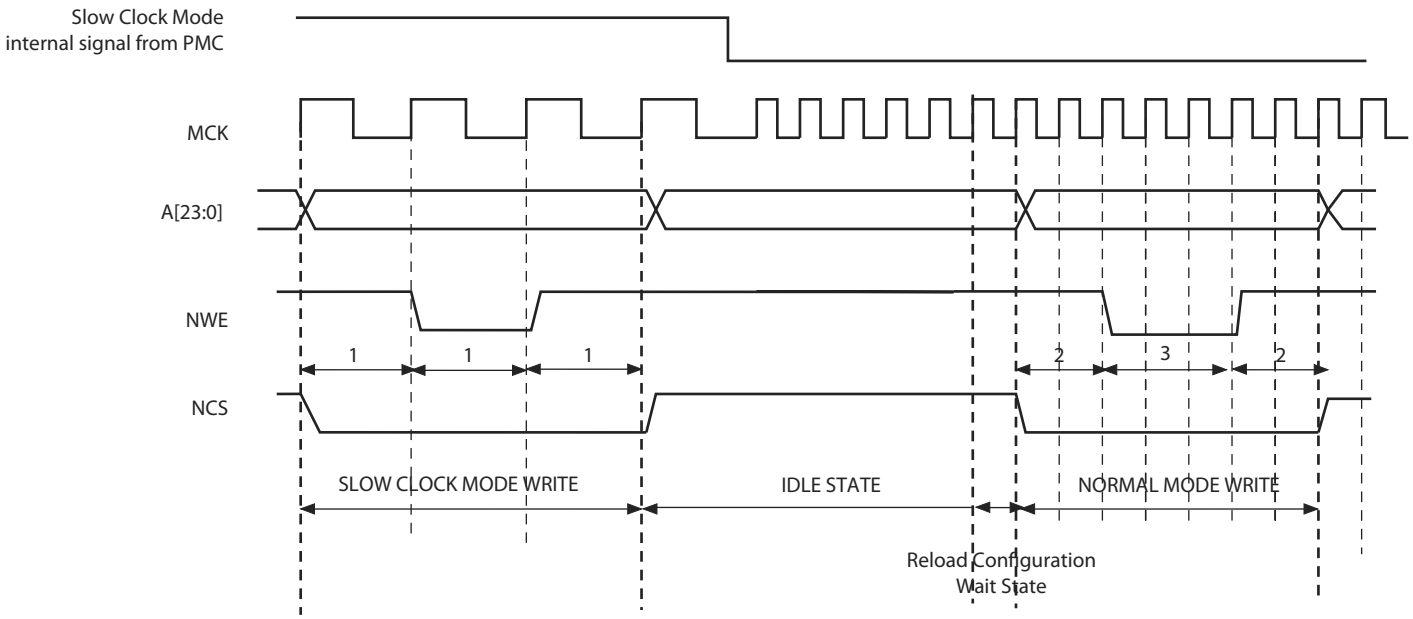


Figure 26-30. Recommended Procedure to Switch from Slow Clock Mode to Normal Mode or from Normal Mode to Slow Clock Mode



In Page mode, the programming of the read timings is described in Table 26-8:

Table 26-8. Programming of Read Timings in Page Mode

Parameter	Value	Definition
READ_MODE	'x'	No impact
NCS_RD_SETUP	'x'	No impact
NCS_RD_PULSE	t_{pa}	Access time of first access to the page
NRD_SETUP	'x'	No impact
NRD_PULSE	t_{sa}	Access time of subsequent accesses in the page
NRD_CYCLE	'x'	No impact

The SMC does not check the coherency of timings. It will always apply the NCS_RD_PULSE timings as page access timing (t_{pa}) and the NRD_PULSE for accesses to the page (t_{sa}), even if the programmed value for t_{pa} is shorter than the programmed value for t_{sa}.

26.15.2 Page Mode Restriction

The Page mode is not compatible with the use of the NWAIT signal. Using the Page mode and the NWAIT signal may lead to unpredictable behavior.

26.15.3 Sequential and Non-sequential Accesses

If the chip select and the MSB of addresses as defined in Table 26-7 are identical, then the current access lies in the same page as the previous one, and no page break occurs.

Using this information, all data within the same page, sequential or not sequential, are accessed with a minimum access time (t_{sa}). Figure 26-32 illustrates access to an 8-bit memory device in Page mode, with 8-byte pages. Access to D1 causes a page access with a long access time (t_{pa}). Accesses to D3 and D7, though they are not sequential accesses, only require a short access time (t_{sa}).

If the MSB of addresses are different, the SMC performs the access of a new page. In the same way, if the chip select is different from the previous access, a page break occurs. If two sequential accesses are made to the Page mode memory, but separated by an other internal or external peripheral access, a page break occurs on the second access because the chip select of the device was deasserted between both accesses.

29. Power Management Controller (PMC)

29.1 Description

The Power Management Controller (PMC) optimizes power consumption by controlling all system and user peripheral clocks. The PMC enables/disables the clock inputs to many of the peripherals and the Cortex-M4 processor.

The Supply Controller selects between the 32 kHz RC oscillator or the slow crystal oscillator. The unused oscillator is disabled automatically so that power consumption is optimized.

By default, at startup, the chip runs out of the master clock using the fast RC oscillator running at 4 MHz.

The user can trim the 8 and 12 MHz RC oscillator frequencies by software.

29.2 Embedded Characteristics

The PMC provides the following clocks:

- MCK, the Master Clock, programmable from a few hundred Hz to the maximum operating frequency of the device. It is available to the modules running permanently, such as the Enhanced Embedded Flash Controller.
- Processor Clock (HCLK) , automatically switched off when entering the processor in Sleep Mode
- Free-running processor Clock (FCLK)
- The Cortex-M4 SysTick external clock
- UDP Clock (UDPCK), required by USB Device Port operations
- Peripheral Clocks, provided to the embedded peripherals (USART, SPI, TWI, TC, etc.) and independently controllable.
- Programmable Clock Outputs (PCKx), selected from the clock generator outputs to drive the device PCK pins

The PMC also provides the following operations on clocks:

- A main crystal oscillator clock failure detector
- A frequency counter on main clock and an on-the-fly adjustable main RC oscillator frequency

29.17.11PMC Master Clock Register

Name: PMC_MCKR

Address: 0x400E0430

Access: Read/Write

31	30	29	28	27	26	25	24
–	–	–	–	–	–	–	–

23	22	21	20	19	18	17	16
–	–	–	–	–	–	–	–

15	14	13	12	11	10	9	8
–	–	PLLBDIV2	PLLADIV2	–	–	–	–

7	6	5	4	3	2	1	0
–	PRES			–	–	CSS	

This register can only be written if the WPEN bit is cleared in the PMC Write Protection Mode Register.

- **CSS: Master Clock Source Selection**

Value	Name	Description
0	SLOW_CLK	Slow Clock is selected
1	MAIN_CLK	Main Clock is selected
2	PLLA_CLK	PLLA Clock is selected
3	PLLB_CLK	PLLBClock is selected

- **PRES: Processor Clock Prescaler**

Value	Name	Description
0	CLK_1	Selected clock
1	CLK_2	Selected clock divided by 2
2	CLK_4	Selected clock divided by 4
3	CLK_8	Selected clock divided by 8
4	CLK_16	Selected clock divided by 16
5	CLK_32	Selected clock divided by 32
6	CLK_64	Selected clock divided by 64
7	CLK_3	Selected clock divided by 3

- **PLLADIV2: PLLA Divisor by 2**

PLLADIV2	PLLA Clock Division
0	PLLA clock frequency is divided by 1.
1	PLLA clock frequency is divided by 2.

31. Parallel Input/Output Controller (PIO)

31.1 Description

The Parallel Input/Output Controller (PIO) manages up to 32 fully programmable input/output lines. Each I/O line may be dedicated as a general-purpose I/O or be assigned to a function of an embedded peripheral. This ensures effective optimization of the pins of the product.

Each I/O line is associated with a bit number in all of the 32-bit registers of the 32-bit wide user interface.

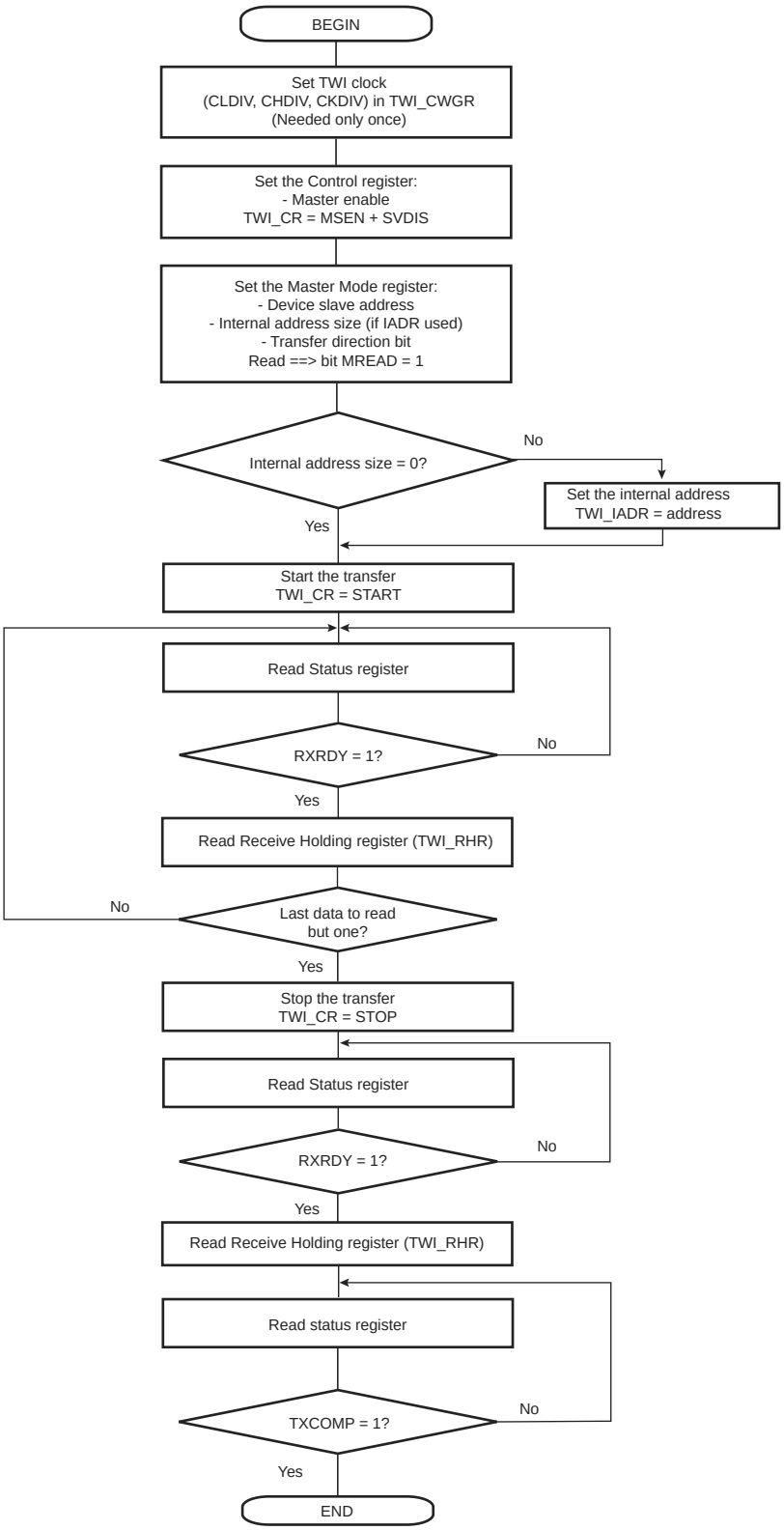
Each I/O line of the PIO Controller features:

- An input change interrupt enabling level change detection on any I/O line.
- Additional Interrupt modes enabling rising edge, falling edge, low-level or high-level detection on any I/O line.
- A glitch filter providing rejection of glitches lower than one-half of peripheral clock cycle.
- A debouncing filter providing rejection of unwanted pulses from key or push button operations.
- Multi-drive capability similar to an open drain I/O line.
- Control of the pull-up and pull-down of the I/O line.
- Input visibility and output control.

The PIO Controller also features a synchronous output providing up to 32 bits of data output in a single write operation.

An 8-bit parallel capture mode is also available which can be used to interface a CMOS digital image sensor, an ADC, a DSP synchronous port in synchronous mode, etc.

Figure 34-19. TWI Read Operation with Multiple Data Bytes with or without Internal Address



- **FCS: Force SPI Chip Select**

Applicable if USART operates in SPI master mode (USART_MODE = 0xE):

0: No effect.

1: Forces the Slave Select Line NSS (RTS pin) to 0, even if USART is not transmitting, in order to address SPI slave devices supporting the CSAAT mode (Chip Select Active After Transfer).

- **RCS: Release SPI Chip Select**

Applicable if USART operates in SPI master mode (USART_MODE = 0xE):

0: No effect.

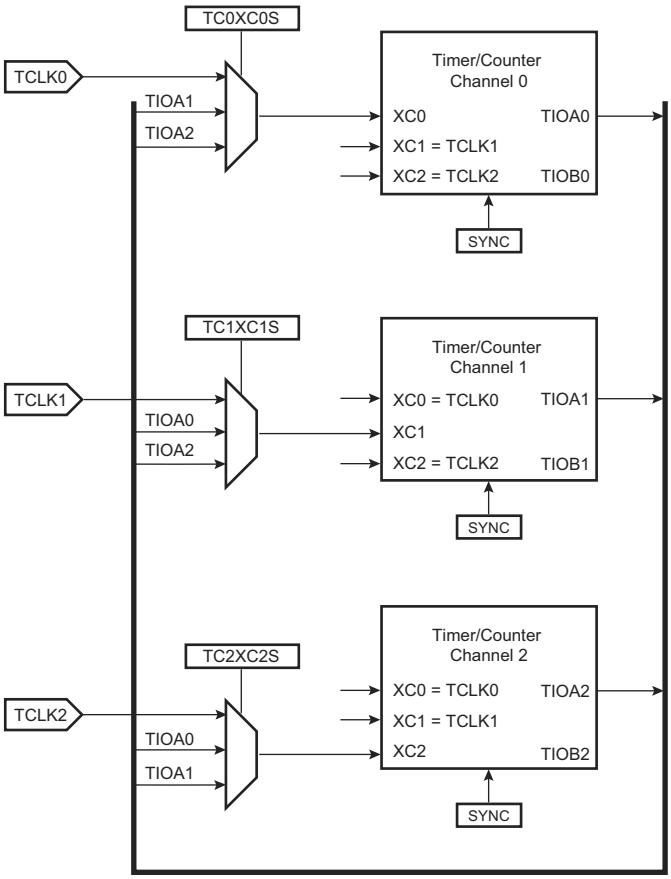
1: Releases the Slave Select Line NSS (RTS pin).

The selected clock can be inverted with the CLKI bit in the TC_CMR. This allows counting on the opposite edges of the clock.

The burst function allows the clock to be validated when an external signal is high. The BURST parameter in the TC_CMR defines this signal (none, XC0, XC1, XC2). See Figure 37-3.

Note: 1. In all cases, if an external clock is used, the duration of each of its levels must be longer than the peripheral clock period. The external clock frequency must be at least 2.5 times lower than the peripheral clock.

Figure 37-2. Clock Chaining Selection



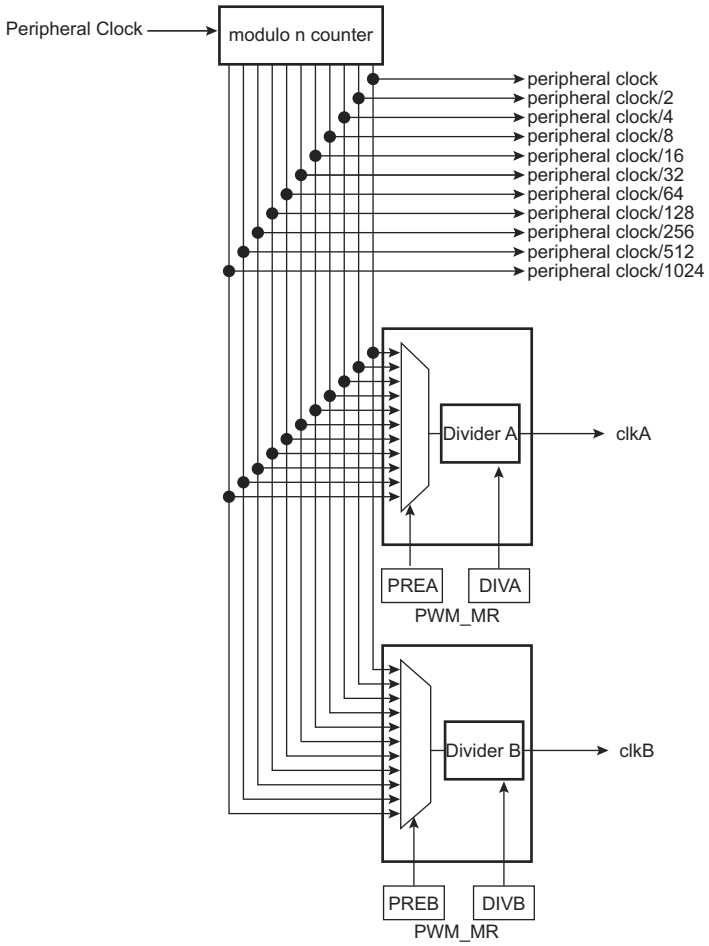
39.6 Functional Description

The PWM controller is primarily composed of a clock generator module and 4 channels.

- Clocked by the peripheral clock, the clock generator module provides 13 clocks.
- Each channel can independently choose one of the clock generator outputs.
- Each channel generates an output waveform with attributes that can be defined independently for each channel through the user interface registers.

39.6.1 PWM Clock Generator

Figure 39-2. Functional View of the Clock Generator Block Diagram



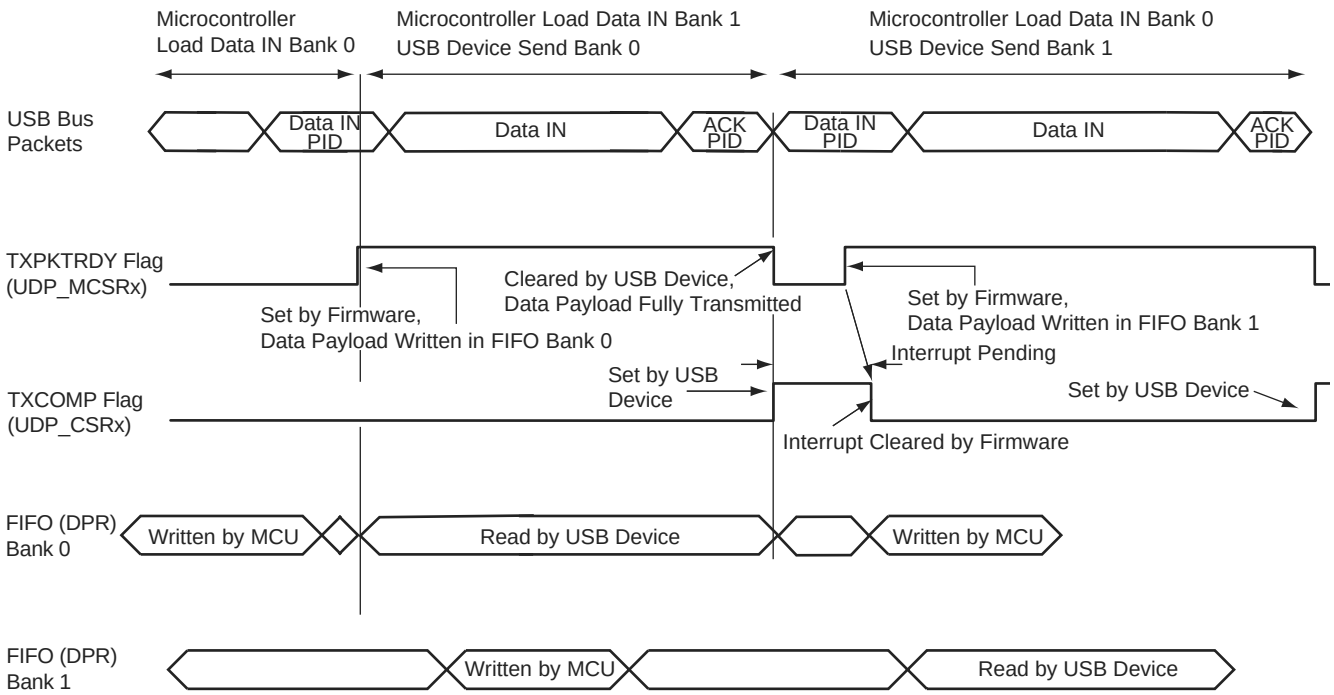
The PWM peripheral clock is divided in the clock generator module to provide different clocks available for all channels. Each channel can independently select one of the divided clocks.

The clock generator is divided into different blocks:

- a modulo n counter which provides 11 clocks: $f_{peripheral\ clock}$, $f_{peripheral\ clock}/2$, $f_{peripheral\ clock}/4$, $f_{peripheral\ clock}/8$, $f_{peripheral\ clock}/16$, $f_{peripheral\ clock}/32$, $f_{peripheral\ clock}/64$, $f_{peripheral\ clock}/128$, $f_{peripheral\ clock}/256$, $f_{peripheral\ clock}/512$, $f_{peripheral\ clock}/1024$
- two linear dividers (1, 1/2, 1/3, ... 1/255) that provide two separate clocks: clkA and clkB

Each linear divider can independently divide one of the clocks of the modulo n counter. The selection of the clock to be divided is made according to the PREA (PREB) field of the PWM Clock register (PWM_CLK). The resulting clock clkA (clkB) is the clock selected divided by DIVA (DIVB) field value.

Figure 40-8. Data IN Transfer for Ping-pong Endpoint



Warning: There is software critical path due to the fact that once the second bank is filled, the driver has to wait for TX_COMP to set TX_PKTRDY. If the delay between receiving TX_COMP is set and TX_PKTRDY is set too long, some Data IN packets may be NACKed, reducing the bandwidth.

Warning: TX_COMP must be cleared after TX_PKTRDY has been set.

40.6.2.3 Data OUT Transaction

Data OUT transactions are used in control, isochronous, bulk and interrupt transfers and conduct the transfer of data from the host to the device. Data OUT transactions in isochronous transfers must be done using endpoints with ping-pong attributes.

Data OUT Transaction Without Ping-pong Attributes

To perform a Data OUT transaction, using a non ping-pong endpoint:

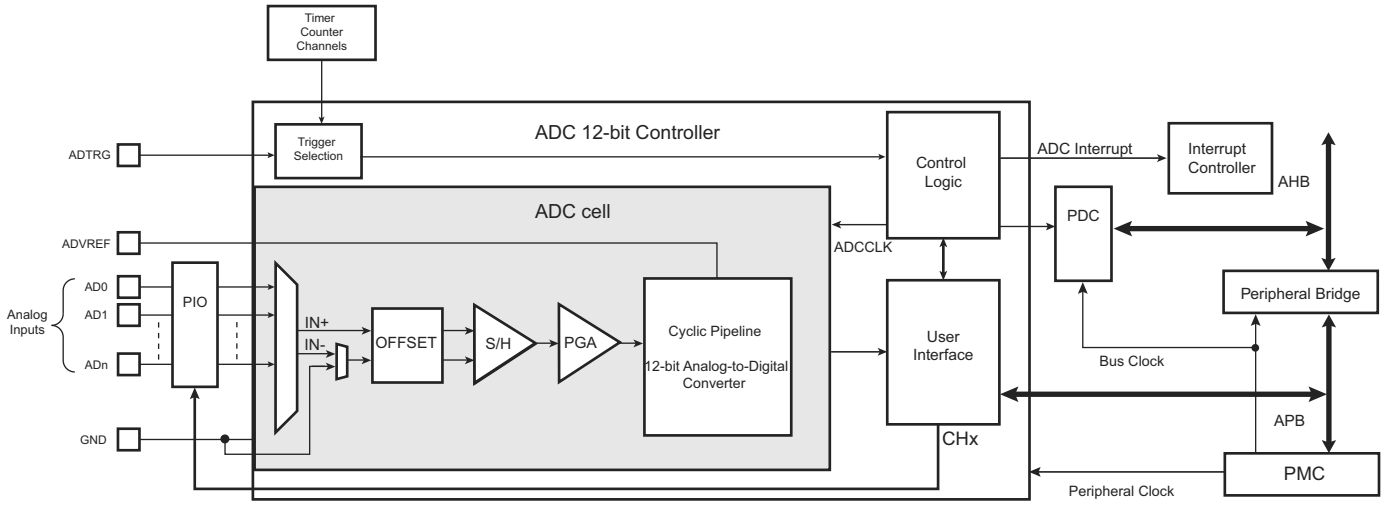
1. The host generates a Data OUT packet.
2. This packet is received by the USB device endpoint. While the FIFO associated to this endpoint is being used by the microcontroller, a NAK PID is returned to the host. Once the FIFO is available, data are written to the FIFO by the USB device and an ACK is automatically carried out to the host.
3. The microcontroller is notified that the USB device has received a data payload polling RX_DATA_BK0 in the endpoint's UDP_CSRx. An interrupt is pending for this endpoint while RX_DATA_BK0 is set.
4. The number of bytes available in the FIFO is made available by reading RXBYTECNT in the endpoint's UDP_CSRx.
5. The microcontroller carries out data received from the endpoint's memory to its memory. Data received is available by reading the endpoint's UDP_FDRx.
6. The microcontroller notifies the USB device that it has finished the transfer by clearing RX_DATA_BK0 in the endpoint's UDP_CSRx.
7. A new Data OUT packet can be accepted by the USB device.

42.2 Embedded Characteristics

- 12-bit Resolution
- 1 MHz Conversion Rate
- On-chip Temperature Sensor Management
- Wide Range of Power Supply Operation
- Selectable Single-Ended or Differential Input Voltage
- Programmable Gain For Maximum Full-Scale Input Range 0–V_{DD}
- Integrated Multiplexer Offering Up to 16 Independent Analog Inputs
- Individual Enable and Disable of Each Channel
- Hardware or Software Trigger
  - External Trigger Pin
  - Timer Counter Outputs (Corresponding TIOA Trigger)
  - PWM Event Line
- Drive of PWM Fault Input
- PDC Support
- Possibility of ADC Timings Configuration
- Two Sleep Modes and Conversion Sequencer
  - Automatic Wakeup on Trigger and Back to Sleep Mode after Conversions of all Enabled Channels
  - Possibility of Customized Channel Sequence
- Standby Mode for Fast Wakeup Time Response
  - Power Down Capability
- Automatic Window Comparison of Converted Values
- Register Write Protection

42.3 Block Diagram

Figure 42-1. Analog-to-Digital Converter Block Diagram



Note: DMA may be referred to as PDC (Peripheral DMA Controller).

42.4 Signal Description

Table 42-1. ADC Pin Description

Pin Name	Description
ADVREF	reference voltage
AD0–AD15[1]	Analog input channels
ADTRG	External trigger

Note: 1. AD15 is not an actual pin but is internally connected to a temperature sensor.

43.7.11 DACC Analog Current Register

Name: DACC_ACR

Address: 0x4003C094

Access: Read/Write

31	30	29	28	27	26	25	24
–	–	–	–	–	–	–	–
23	22	21	20	19	18	17	16
–	–	–	–	–	–	–	–
15	14	13	12	11	10	9	8
–	–	–	–	–	–	IBCTLDACCORE	
7	6	5	4	3	2	1	0
–	–	–	–	IBCTLCH1		IBCTLCH0	

This register can only be written if the WPEN bit is cleared in the DACC Write Protection Mode Register.

- **IBCTLCHx: Analog Output Current Control**

Used to modify the slew rate of the analog output (See the product Electrical Characteristics section for further details.)

- **IBCTLDACCORE: Bias Current Control for DAC Core**

Used to modify performance versus power consumption (See the product Electrical Characteristics section for further details.)

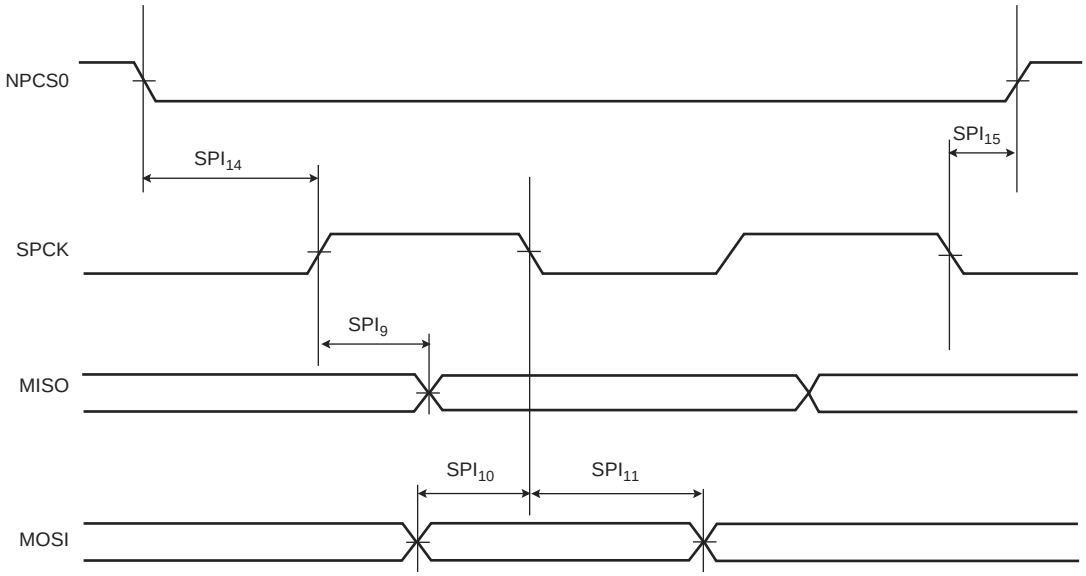
Table 44-59. Dynamic Performance Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
SNR	Signal to Noise Ratio	DAC Clock (f_{DAC}) = 50 MHz, f_S = 2 MHz, f_{IN} = 241 kHz, ADC_ACR.IBCTL = 01, FFT using 1024 points or more, Frequency band = [10 kHz–1 MHz] Nyquist conditions fulfilled	2.4V < V_{DDIN} < 2.7V	50	62	70	dB
			2.7V < V_{DDIN} < 3.6V	62	70	74	
THD	Total Harmonic Distortion		2.4V < V_{DDIN} < 2.7V	-78	-64	-60	dB
			2.7V < V_{DDIN} < 3.6V	-80	-74	-72	
SINAD	Signal to Noise and Distortion		2.4V < V_{DDIN} < 2.7V	50	60	70	dB
			2.7V < V_{DDIN} < 3.6V	62	68	73	
ENOB	Effective Number of Bits		2.4V < V_{DDIN} < 2.7V	8	10	12	bit
			2.7V < V_{DDIN} < 3.6V	10	11	12	

Table 44-60. Analog Outputs

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{OR}	Voltage Range		(1/6) × V_{ADVREF}	–	(5/6) × V_{ADVREF}	V
SR	Slew Rate	Channel output current versus slew rate (IBCTL for DAC0 or DAC1, noted IBCTLCHx) R_{LOAD} = 10 kΩ, 0 pF < C_{LOAD}< 50 pF IBCTLCHx = 00 IBCTLCHx = 01 IBCTLCHx = 10 IBCTLCHx = 11	–	 2.7 5.3 8 10.7	–	V/µs
	Output Channel Current Consumption	No resistive load IBCTLCHx = 00 IBCTLCHx = 01 IBCTLCHx = 10 IBCTLCHx = 11	–	 0.23 0.45 0.67 0.89	–	mA
t_{sa}	Settling Time	R_{LOAD} = 10 kΩ, 0 pF < C_{LOAD}< 50 pF	–	–	0.5	µs
R_{LOAD}	Output load resistor		10	–	–	kΩ
C_{LOAD}	Output load capacitor		–	30	50	pF

Figure 44-25. SPI Slave Mode with (CPOL = NCPHA = 0) or (CPOL = NCPHA = 1)



44.12.3.1 Maximum SPI Frequency

The following formulas give maximum SPI frequency in master read and write modes and in slave read and write modes.

Master Write Mode

The SPI only sends data to a slave device such as an LCD, for example. The limit is given by SPI_2 (or SPI_5) timing. Since it gives a maximum frequency above the maximum pad speed (see Section 44.12.2 “I/O Characteristics”), the maximum SPI frequency is defined by the pin FreqMax value.

Master Read Mode

$$f_{SPCK}Max = \frac{1}{SPI_0(orSPI_3) + t_{valid}}$$

t_{valid} is the slave time response to output data after detecting an SPCK edge. For a non-volatile memory with t_{valid} (or t_V) = 12 ns Max, f_{SPCK}Max = 35.5 MHz @ V_{DDIO} = 3.3V.

Slave Read Mode

In slave mode, SPCK is the input clock for the SPI. The maximum SPCK frequency is given by setup and hold timings SPI_7/SPI_8 (or SPI_{10}/SPI_{11}). Since this gives a frequency well above the pad limit, the limit in slave read mode is given by SPCK pad.

Slave Write Mode

$$f_{SPCK}Max = \frac{1}{2x(SPI_{6max}(orSPI_{9max}) + t_{su})}$$

For 3.3V I/O domain and SPI6, f_{SPCK}Max = 25 MHz. t_{su} is the setup time from the master before sampling data.